

#### **1200V SIC MOSFET**

#### **Features**

- High blocking voltage with low Rds(on)
- High frequency operation with low Capacitance
- Simple to drive with -4V/+15V gate
- Robust body diode with low Qrr
- 100% Avalanche Tested

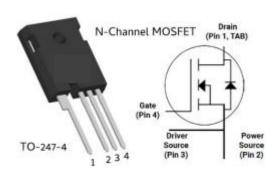
### **Applications**

- EV motor drives
- EV/HEV charging station
- Energy storage and Battery charging
- High voltage DC-DC converters
- Solar / Wind Inverters
- UPS and PFC

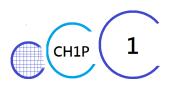
#### **Product Summary**

Item	Typical Value	Unit
V <sub>DS</sub>	1200	V
R <sub>DS(on)</sub> @ V <sub>GS</sub> =15V (Typ)	15	mΩ
I <sub>D</sub>	155	Α

#### **Pin Description**







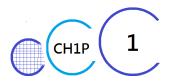
### **Absolute Ratings** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Units
Drain-Source Voltage	V <sub>DS</sub>	1200	V
Gate-Source Voltage	V <sub>G</sub> S	-4/+15	V
Continuous Drain Current	Ips	155	А
Pulsed Drain Current	Ірм	313	А
Total Power Dissipation	PD	652	W
Junction Temperature Maximum	Тлмах	175	°C
Storage Temperature	Tstorage	-55 to 175	°C



### **Electrical Characteristics** (T<sub>A</sub> = 25° cunless otherwise noted)

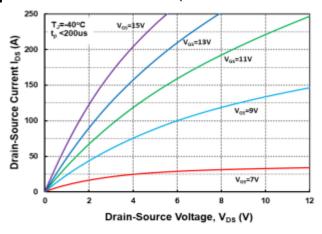
	Static (T	=25°C unless otherwise specified)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units	
Drain-Source Breakdown Voltage	BVDSS	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA	1200			V	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 1200V, V <sub>GS</sub> = 0V			60	uA	
Cata Laglaga Current	1	$V_{GS} = 15V, V_{DS} = 0V$	0	5	100	-	
Gate Leakage Current	IGSS	V <sub>GS</sub> = -4V, V <sub>DS</sub> = 0V	-100	-5	0	mA	
Drain-Source On-State Resistance	RDS(on)	V <sub>GS</sub> = 15V, I <sub>D</sub> = 75A		15	20	mΩ	
Gate-Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}$ , $I_D = 30 \text{mA}$	1.8		3.2	V	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> = 40A, V <sub>GS</sub> = -4V		4.2		V	
	Dynamic (	T <sub>J</sub> =25°C unless otherwise specified)	)				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units	
Input Capacitance	Ciss			6550			
Output Capacitance	Coss	1 - 1001(12			pF		
Reverse Transfer Capacitance	Crss			10		]	
Turn-On Switching Energy	Eon	$V_{DS} = 800V, I_{D} = 75A,$		804		1	
Turn-Off Switching Energy	Eoff	$V_{GS} = -4V/15V, R_{G}=2\Omega,$ 201			— uJ		
Total Gate Charge	Qg			235			
Gate-Source Charge	Qgs	$V_{DS} = 800V, I_{D} = 75A,$ $V_{GS} = -4V/15V$		74		nC	
Gate-Drain Charge	Qgd			73			
Turn-on delay time	T <sub>d(on)</sub>			15			
Rise time	Tr	$V_{DS} = 800V, I_{D} = 75A,$		33		20	
Turn-off delay time	T <sub>d(off)</sub>	$V_{GS} = -4V/15V, R_{G}=2\Omega,$ 63			nS nS		
Fall time	Tf			14			
Internal gate input resistance	Rg	f=1MHz, I <sub>D</sub> = 0A		3		Ω	



T<sub>J</sub>=25°C t<sub>p</sub> <200us

200

#### **Typical Characteristics** (T<sub>A</sub> = 25°C unless otherwise noted)

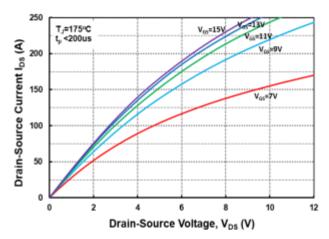


Drain-Source Current IDS (A) 150 100 V<sub>GS</sub>=7V 50 Drain-Source Voltage, V<sub>DS</sub> (V)

V<sub>65</sub>=11V

Figure 1. Output Characteristics, T<sub>J</sub> = -40°C

Figure 2. Output Characteristics, T<sub>J</sub> = 25°C



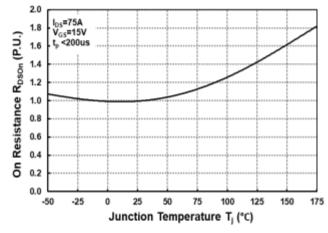
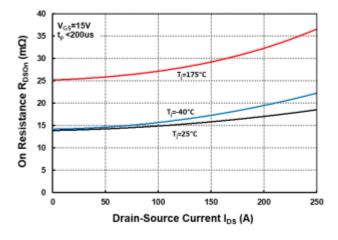


Figure 3. Output Characteristics, TJ = 175°C

Figure 4. Normalized On-Resistance vs. Temperature



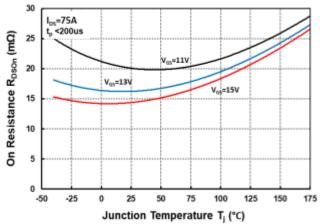
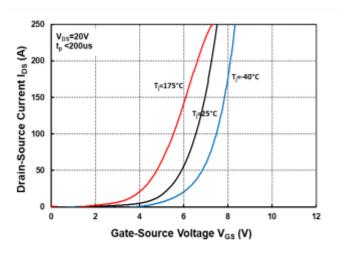


Figure 5. On-Resistance vs. Drain Current for Various Temperatures

Figure 6. On-Resistance vs. Temperature for Various Gate Voltage





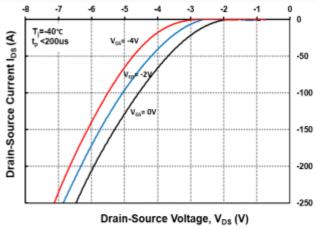
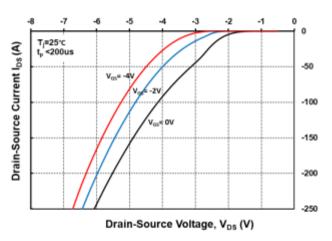


Figure 7. Transfer Characteristic for Various Junction Temperatures

Figure 8. Body Diode Characteristics @ -40°C



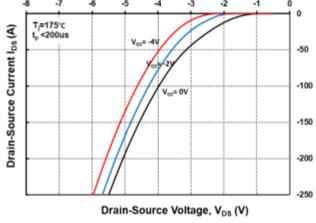
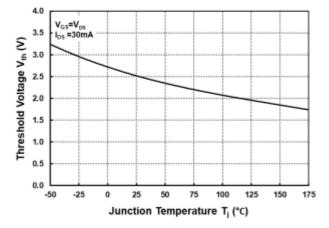


Figure 9. Body Diode Characteristics @ 25°C

Figure 10. Body Diode Characteristics @ 175°C



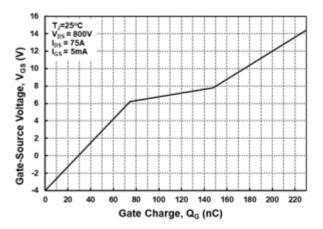


Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics



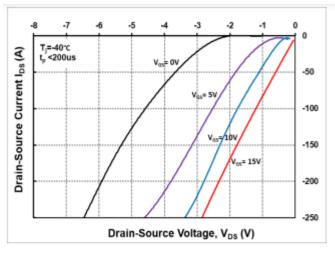


Figure 13. 3rd Quadrant Characteristics @ -40°C

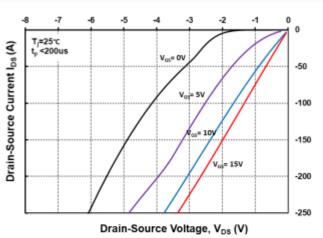


Figure 14. 3rd Quadrant Characteristics @ 25°C

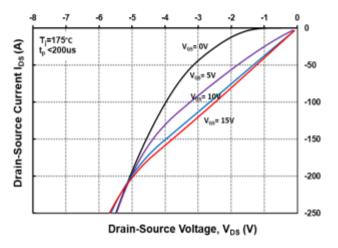


Figure 15. 3rd Quadrant Characteristics @ 175°C

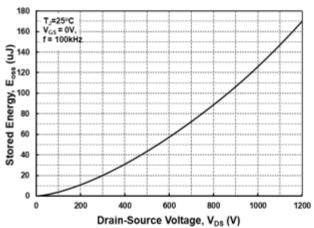


Figure 16. Output Capacitor Stored Energy

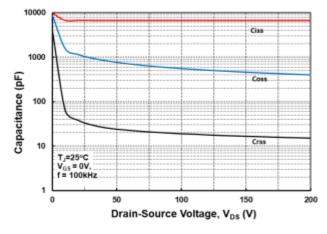


Figure 17. Capacitances vs. Drain-Source Voltage (0-200V)

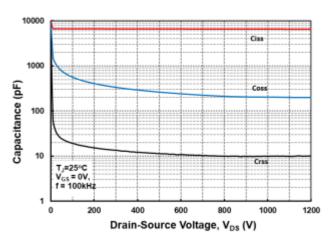
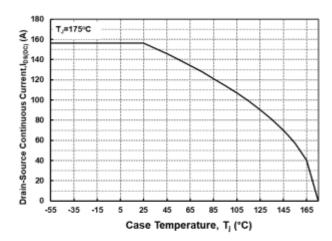


Figure 18. Capacitances vs. Drain-Source Voltage (0-1200V)



#### CMU15C120NH-2474





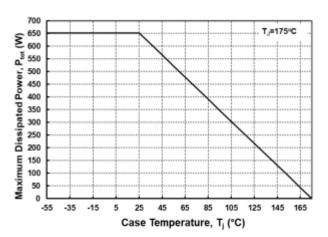
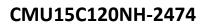


Figure 20. Maximum Power Dissipation Derating vs.

Case Temperature

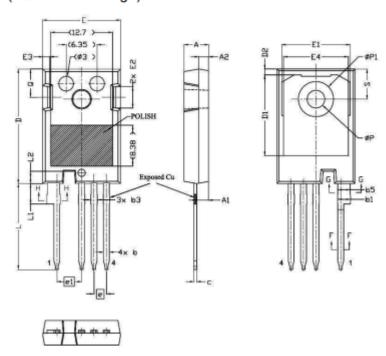




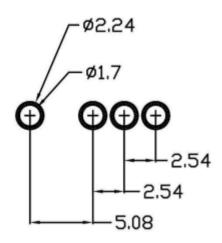


#### **Package Dimensions**

(TO-247-4 Package)



## **Recommended Solder Pad Layout**



SYMBOL	DIMENSIONS			
STMBUL	MIN.	NOM.	MAX	
A	4.83	5.02	5.21	
A1	2.29	2.41	2.54	
A2	1.91	2.00	2.16	
p,	1.07	1.20	1.28	
b	1.07	1.20	1.33	
b1	2.39	2.67	2.94	
b2	2.39	2.67	2.84	
ь3	1.07	1.30	1.60	
b4	1.07	1.30	1.50	
b5	2,39	2.53	2,69	
b6	2.39	2.53	2.64	
c	0.55	0.60	0.68	
c1	0,55	0,60	0,65	
D	23.30	23.45	23.60	
D1	16.25	16.55	17.65	
D2	0.95	1.19	1.25	
Ε	15.75	15,94	16.13	
E1	13.10	14.02	14.15	
E2	3.68	4.40	5.10	
E3	1.00	1.45	1.90	
E4	12.38	13.26	13.43	
0	2.54 BSC			
e1		5.08 BSC		
L.	17.31	17.57	17.82	
L1	3,97	4.19	4,37	
L2	2.35	2.50	2.65	
ØP	3.51	3.61	3.65	
ØP1	7.19 REF.			
Q	5,49	5,79	6,00	
s	6.04	6.17	6.30	